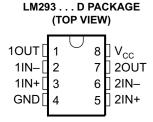
LM293-EP DUAL DIFFERENTIAL COMPARATOR

SLCS155-OCTOBER 2007

FEATURES

- Controlled Baseline
 - One Assembly
 - Test Site
 - One Fabrication Site
- Extended Temperature Performance of -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product Change Notification
- Qualification Pedigree (1)
- Single Supply or Dual Supplies
- · Wide Range of Supply Voltage
 - Max Rating . . . 2 V to 36 V
 - Tested to 30 V
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold-compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- Low Supply-Current Drain Independent of Supply Voltage . . . 0.4 mA Typical Per Comparator
- Low Input Bias Current . . . 25 nA Typical
- Low Input Offset Voltage . . . 2 mV Typical
- Common-Mode Input Voltage Range Includes Ground
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . . ±36 V
- Low Output Saturation Voltage
- Output Compatible With TTL, MOS, and CMOS



DESCRIPTION/ORDERING INFORMATION

This device consist of two independent voltage comparators that are designed to operate from a single power supply over a wide range of voltages. Operation from dual supplies also is possible as long as the difference between the two supplies is 2 V to 36 V, and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. Current drain is independent of the supply voltage. The outputs can be connected to other open-collector outputs to achieve wired-AND relationships.

The LM293-EP is characterized for operation from –55°C to 125°C.

ORDERING INFORMATION(1)

T _A	V _{IOmax} AT 25°C	MAX V _{CC}	PACK	(AGE ⁽²⁾	ORDERABLE PART NUMBER	TOPSIDE MARKING
–55°C to 125°C	5 mV	30 V	SOIC - D	Reel of 2500	LM293MDREP	LM293E

⁽¹⁾ For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



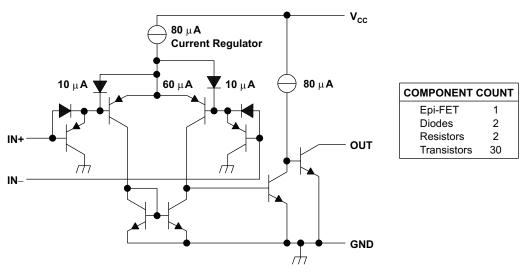
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Symbol (Each Comparator)



Schematic (Each Comparator)



Current values shown are nominal.

Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

				MIN	MAX	UNIT
V _{CC}	Supply voltage (2)				36	V
V_{ID}	Differential input voltage (3)				±36	V
VI	Input voltage range (either input)			-0.3	36	V
Vo	Output voltage			36	V	
Io	Output current				20	mA
	Duration of output short-circuit to ground (4)			Į	Jnlimited	
θ_{JA}	Package thermal impedance ⁽⁵⁾⁽⁶⁾	D package			97	°C/W
T_{J}	Operating virtual junction temperature				150	Ô
T _{stg}	Storage temperature range			-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltage values, except differential voltages, are with respect to GND.

Differential voltages are at IN+, with respect to IN-. Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction.

Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

The package thermal impedance is calculated in accordance with JESD 51-7.

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Electrical Characteristics

at specified free-air temperature, V_{CC} = 5 V (unless otherwise noted)

	DADAMETED	PARAMETER TEST CONDITIONS		T _A ⁽¹⁾	L	UNIT			
	PARAMETER	TEST CO	SMOITIGNS	IA''	MIN	TYP	MAX	UNII	
		V _{CC} = 5 V to 30 V,		25°C		2	5		
V _{IO}	Input offset voltage	$V_O = 1.4 \text{ V},$ $V_{IC} = V_{IC(min)}$		Full range			9	mV	
L	Input offset current			25°C		5	50	nA	
I _{IO}	input onset current	V _O = 1.4 V		Full range			250	IIA	
	Input bias current	V _O = 1.4 V		25°C		-25	-250	- ^	
I _{IB}	input bias current			Full range			-400	nA	
.,	Common-mode input			25°C	0 to VCC – 1.5				
V _{ICR}	voltage range ⁽²⁾			Full range	0 to VCC – 2			V	
A _{VD}	Large-signal differential-voltage amplification	$V_{CC} = 15 \text{ V},$ $V_{O} = 1.4 \text{ V to } 11.4$ $R_{L} \ge 15 \text{ k}\Omega \text{ to } V_{CO}$	4 V,	25°C	50	200		V/mV	
	High lovel output ourrent	V _{OH} = 5 V,	V _{ID} = 1 V	25°C		0.1	50	nA	
I _{OH}	High-level output current	V _{OH} = 30 V,	V _{ID} = 1 V	Full range			1	μA	
.,	Laurianal andand nakaaa	1 4 1	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	25°C		150	400	\/	
V _{OL}	Low-level output voltage	$I_{OL} = 4 \text{ mA},$ $V_{ID} = -1$		Full range			700	mV	
I _{OL}	Low-level output current	V _{OL} = 1.5 V,	V _{ID} = −1 V	25°C	6			mA	
	Cupaly aurent	Vo		25°C		0.8	1	•	
Icc	Supply current	R _L = ∞	V _{CC} = 30 V	Full range			2.5	mA	

⁽¹⁾ Full range (MIN or MAX) for LM293 is -55°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

Switching Characteristics

 $V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CO	ONDITIONS	LM293	UNIT
TANAMETER	1201 00	TYP	Oili	
Pagnanga tima	R _L connected to 5 V through 5.2 kΩ, C _L = 15 pF ⁽¹⁾ , See ⁽²⁾	100 mV input step with 5 mV overdrive	1.3	
Response time	$C_L = 15 \text{ pF}^{(1)}, \text{ See}^{(2)}$	TTL-level input step	0.3	μs

⁽¹⁾ C_L includes probe and jig capacitance.

⁽²⁾ The voltage at either input or common-mode should not be allowed to go negative by more than 0.3 V. The upper end of the common-mode voltage range is V_{CC+} – 1.5 V for the inverting input (–), and the non-inverting input (+) can exceed the V_{CC} level; the comparator provides a proper output state. Either or both inputs can go to 30 V without damage.

⁽²⁾ The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	_	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM293MDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

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*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
I	LM293MDREP	SOIC	D	8	2500	353.0	353.0	32.0



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



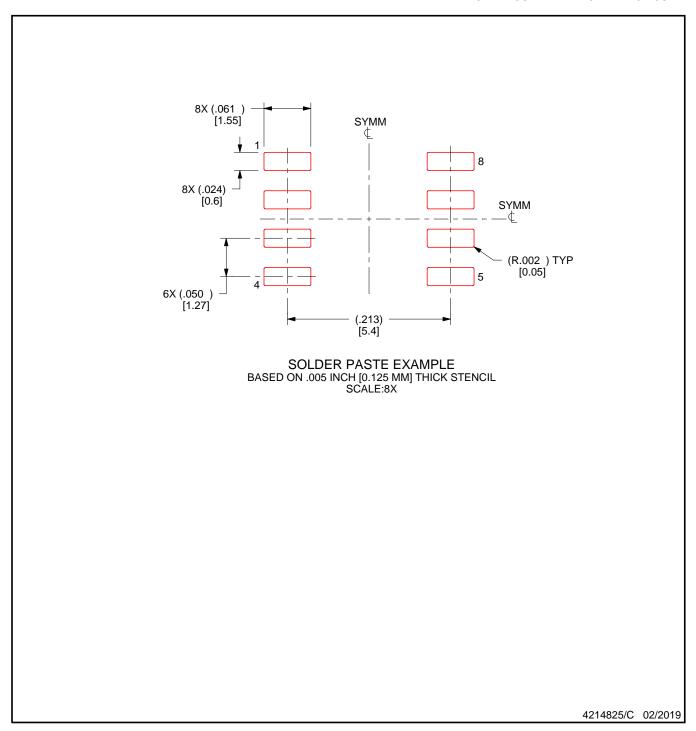
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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